

TOSHIBA LED Lamp

TL(RMH,SH,OH,YH,GH,FGH)1050(T20)

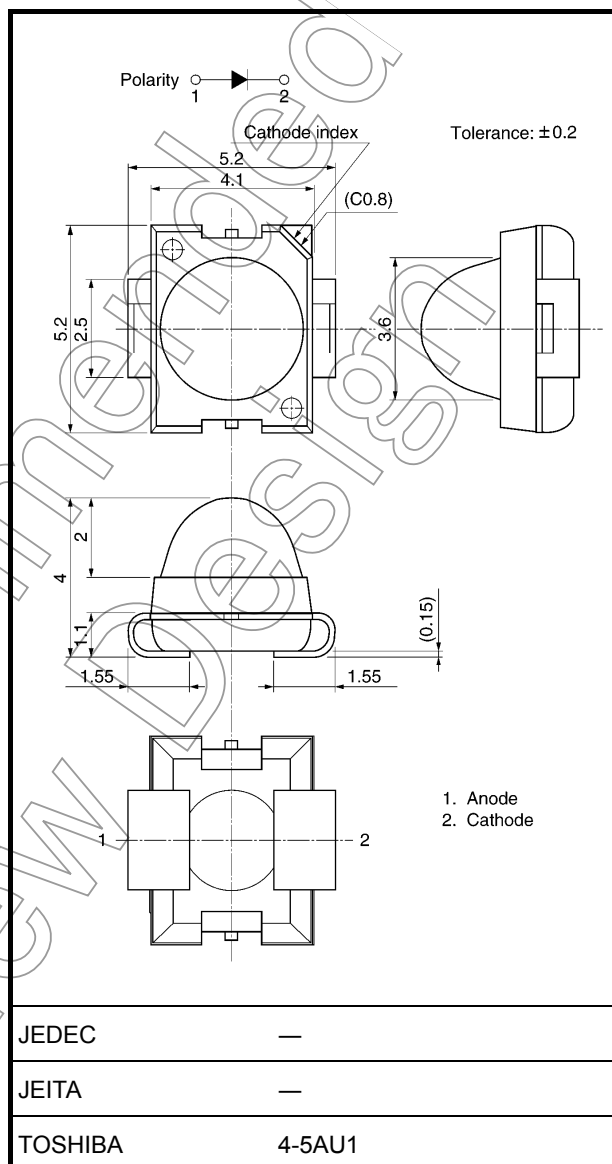
○Panel Circuit Indicator

- 5.2 (L) × 5.2 (W) × 4.0 (H) mm size
- TL□H1050 (T20) Series
 - ϕ 3.6 mm transparent lens top type
- InGaAlP LEDs
- High Luminous Intensity and low power consumption
- Colors :Red, Orange, Yellow, Green
- Clear luminescence is obtained
- High Operating Temperature:
 - T_{opr} : -40 to 100°C
 - T_{stg} : -40 to 110°C
- Can be mounted using surface mounter.
- Standard Embossed Taping
 - 8 mm pitch : T20 (400 pcs/reel)
- Reflow Soldering is possible.
- Applications: portable devices, backlighting, message signboards and amusement etc.

Color and Material

Product Name	Color	Material
TLRMH1050	Red	InGaAlP
TLSH1050	Red	
TLOH1050	Orange	
TLYH1050	Yellow	
TLGH1050	Green	
TLFGH1050	Green	

Unit: mm



Weight: 0.085g (typ.)

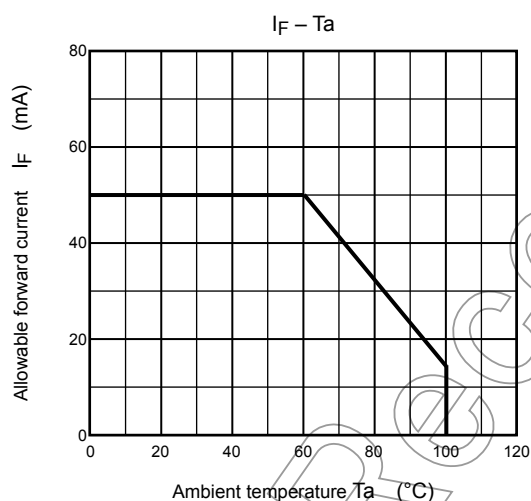
Absolute Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLRMH1050	50	4	120	-40 to 190	-40 to 110
TLSH1050					
TLOH1050					
TLYH1050					
TLGH1050					
TLFGH1050					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Forward current derating



Electrical Characteristics (Ta = 25°C)

Product Name	Forward Voltage V _F			Reverse Current I _R	
	Min	Typ.	Max	I _F	V _R
TLRMH1050	1.7	2.0	2.5	20	50
TLSH1050	1.7	2.0	2.5		
TLOH1050	1.7	2.0	2.5		
TLYH1050	1.7	2.1	2.5		
TLGH1050	1.7	2.1	2.5		
TLFGH1050	1.7	2.1	2.5		
Unit	V			mA	μA

Optical Characteristics-1 (Ta = 25°C)

Product Name	Luminous Intensity I _v			I _F	Corresponding brightness rank sign (Note 2)
	Min	Typ	Max		
TLRMH1050	272	700	2300	20	Q/R/S
TLSH1050	476	1400	4140		R/S/T
TLOH1050	476	1500	4140		R/S/T
TLYH1050	476	1000	2300		R/S
TLGH1050	272	600	1290		Q/R
TLFGH1050	85	250	736		N/P/Q
Unit	mcd			mA	

Note 2: The brightness rank classification executes based on the following rank table, and is classified by the reel.

However, the delivery ratio of each classification is not defined.

Brightness rank		
Rank sign	Min	Max
N	85	230
P	153	414
Q	272	736
R	476	1290
S	850	2300
T	1530	4140
Unit	mcd	mcd

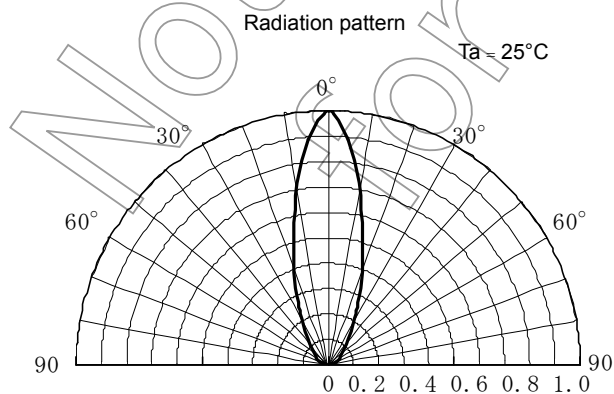
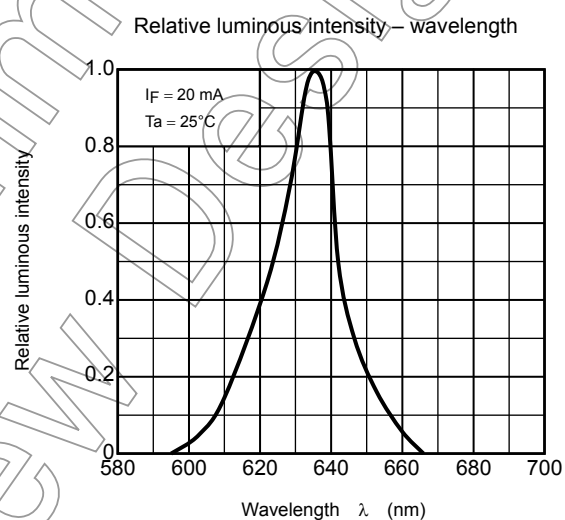
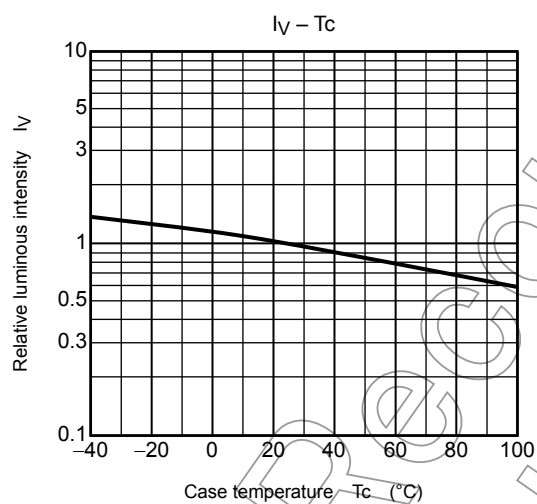
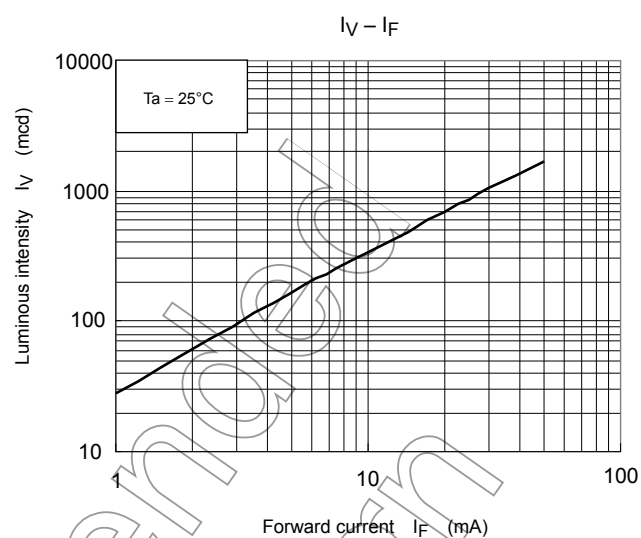
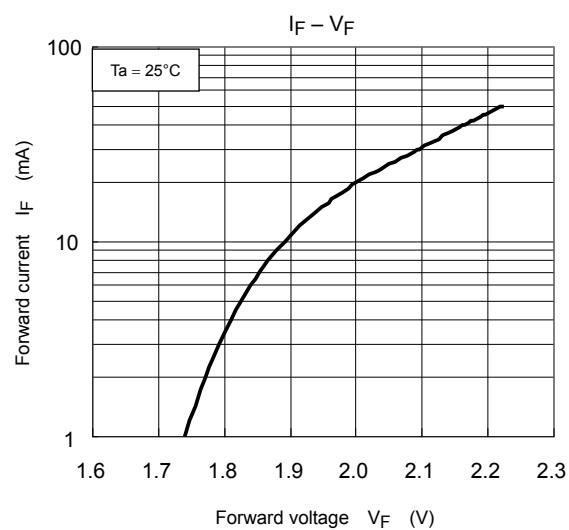
Optical Characteristics-2 (Ta = 25°C)

Product Name	Emission Spectrum							
	Peak Emission Wavelength λ _p			Δλ	Dominant Wavelength λ _d			I _F
	Min	Typ.	Max		Min	Typ.	Max	
TLRMH1050	—	636	—	17	620	626	634	20
TLSH1050	—	623	—	17	607	613	621	
TLOH1050	—	612	—	15	599	605	613	
TLYH1050	—	590	—	13	581	587	595	
TLGH1050	—	574	—	11	565	571	576	
TLFGH1050	—	568	—	11	559	565	571	
Unit	nm			nm	nm			mA

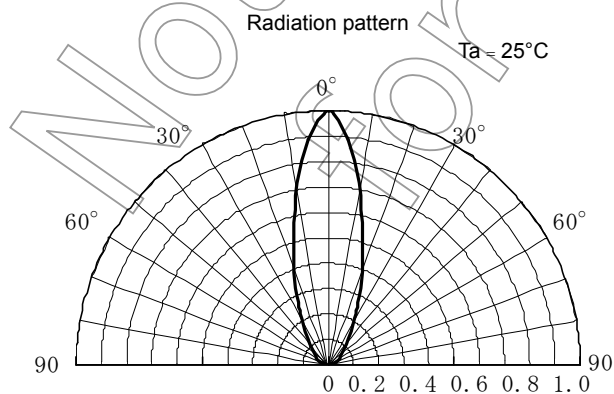
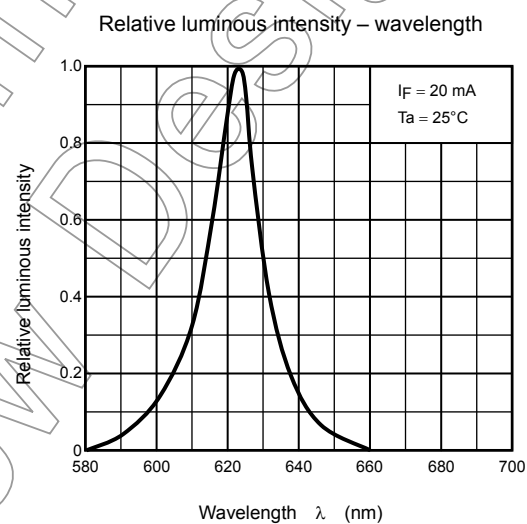
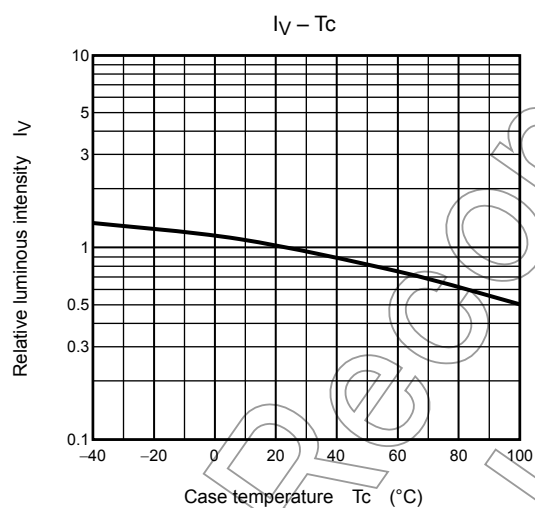
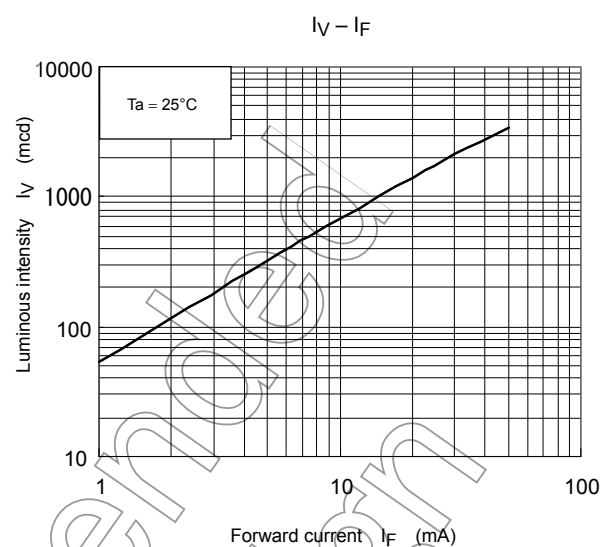
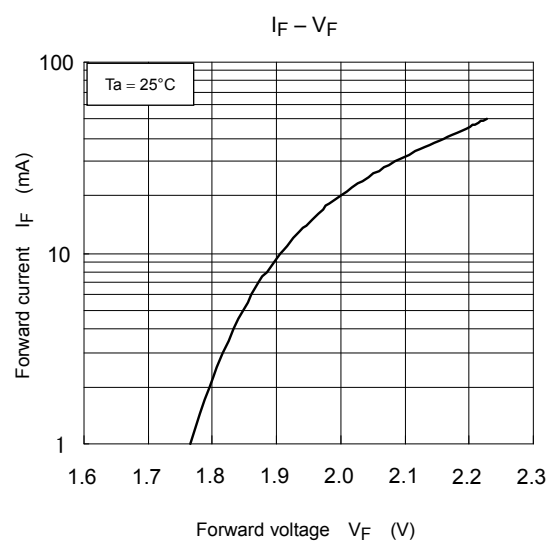
Caution

- This LED lamp emits some infrared light in addition to light in the visible spectrum. Ensure that this IR light affects no photosensitive device used near the LED lamp.
- This product is a product developed as a display source of light usage, and the measurement standard matched to the sensitivity of person eyes is applied.
Therefore, use to functional usages (source of light for the sensor and the communication) other than the source of light for the display is not intended.

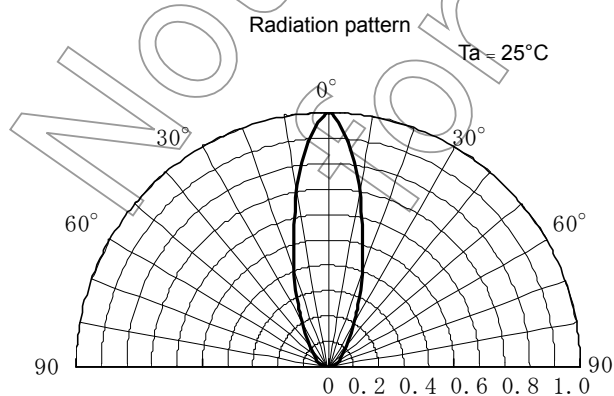
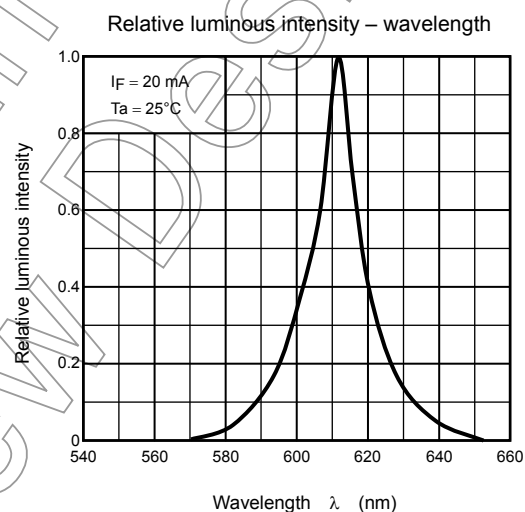
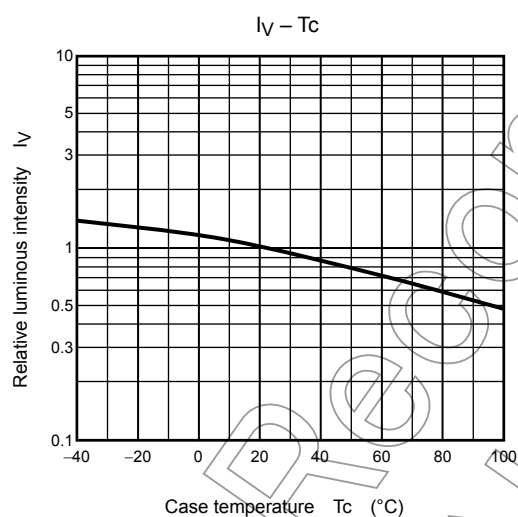
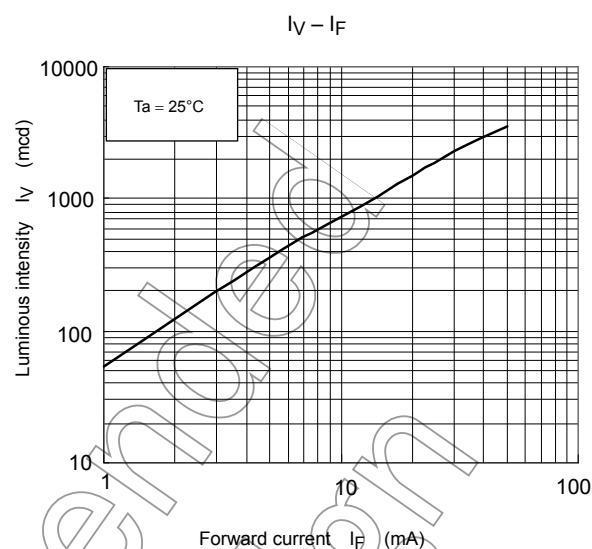
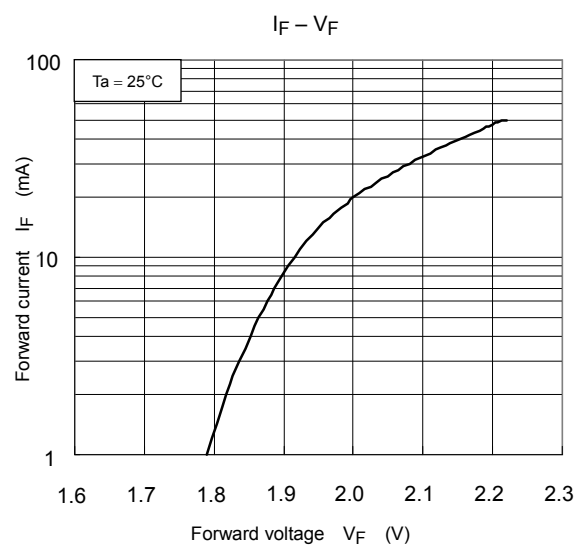
TLRMH1050



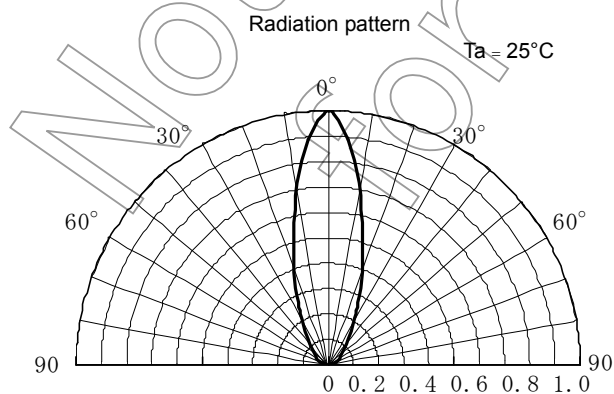
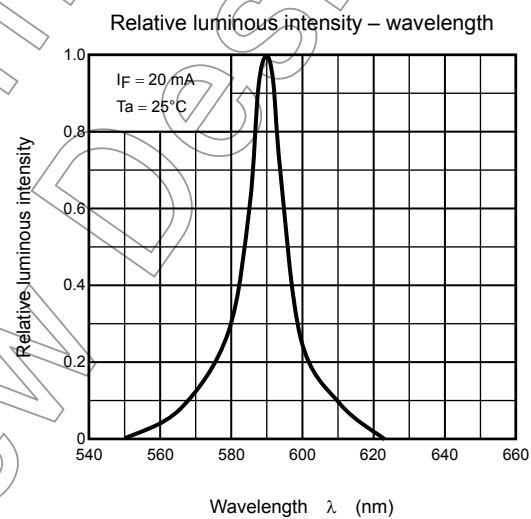
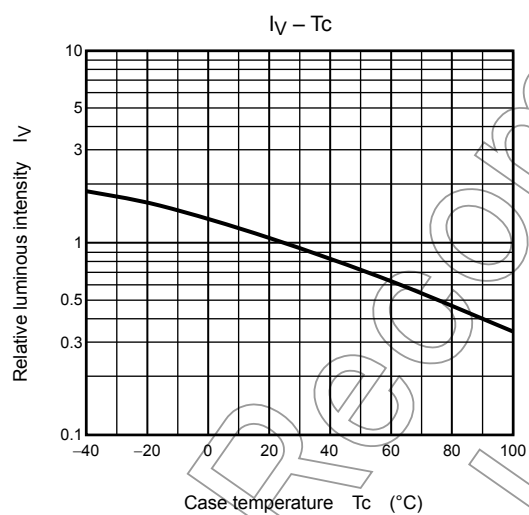
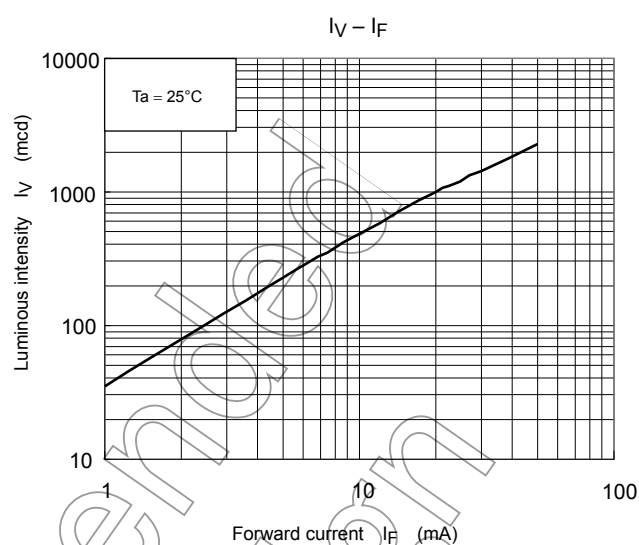
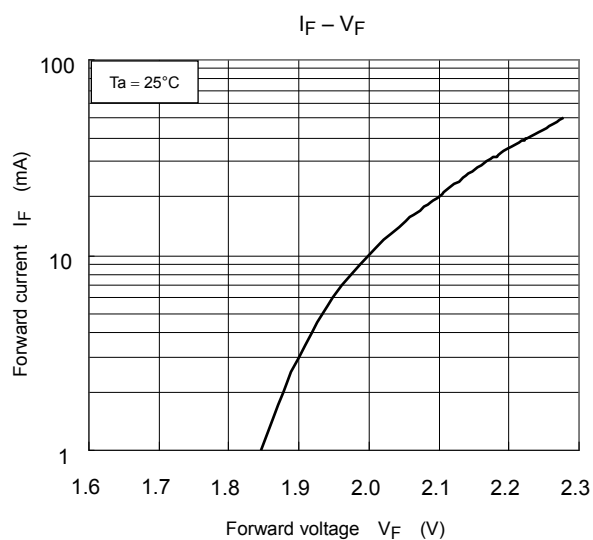
TL5H1050



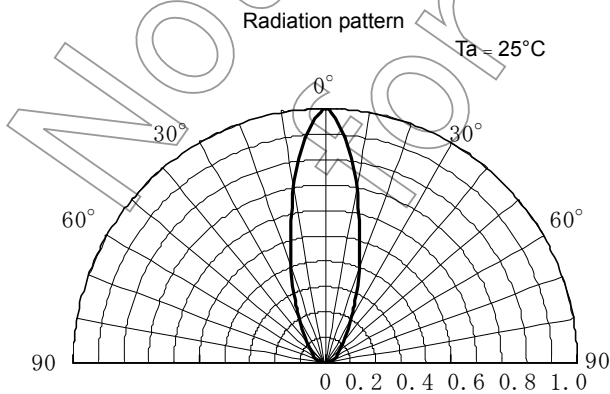
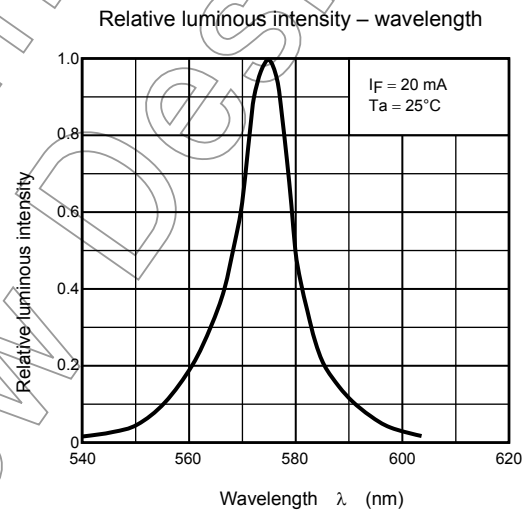
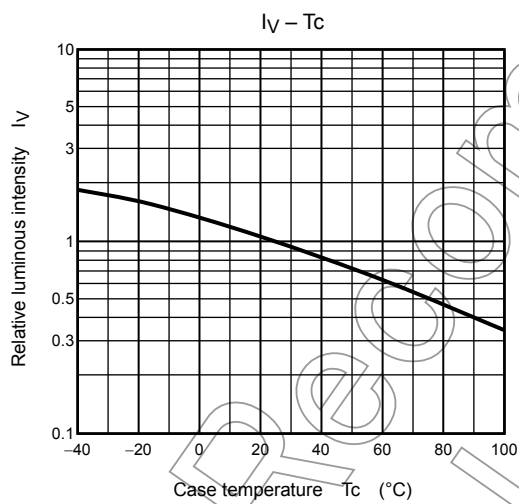
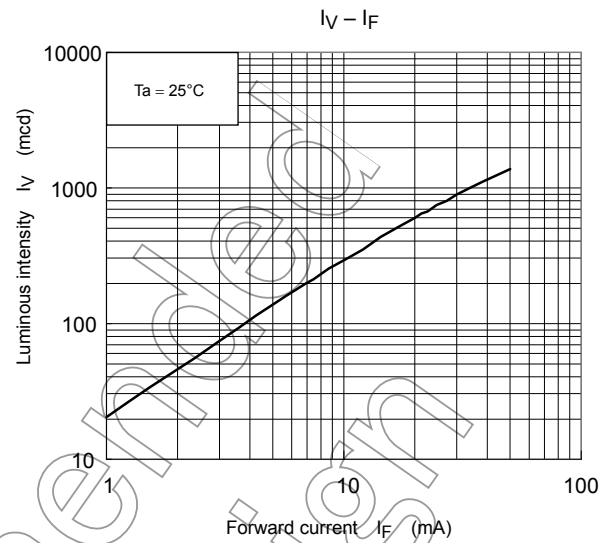
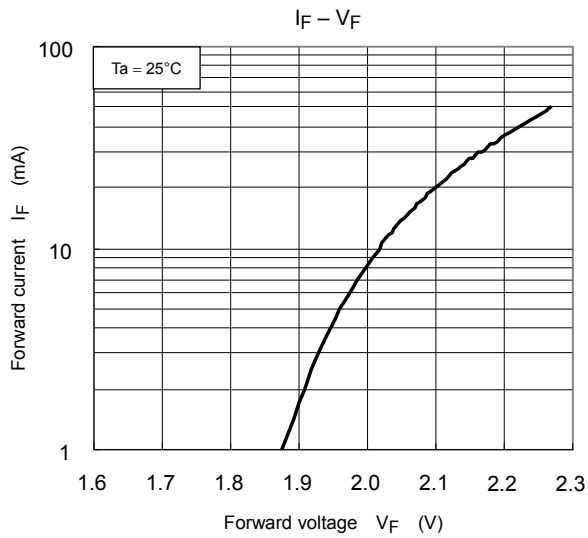
TLOH1050



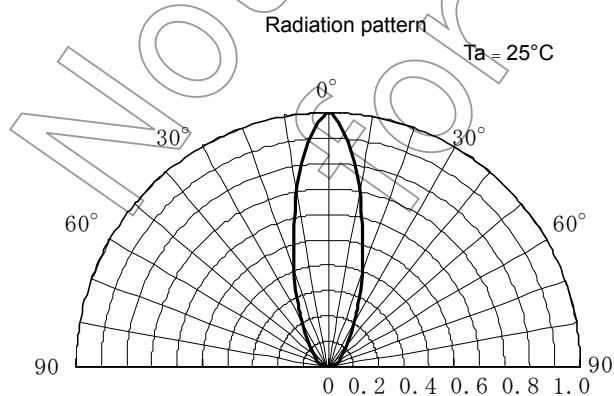
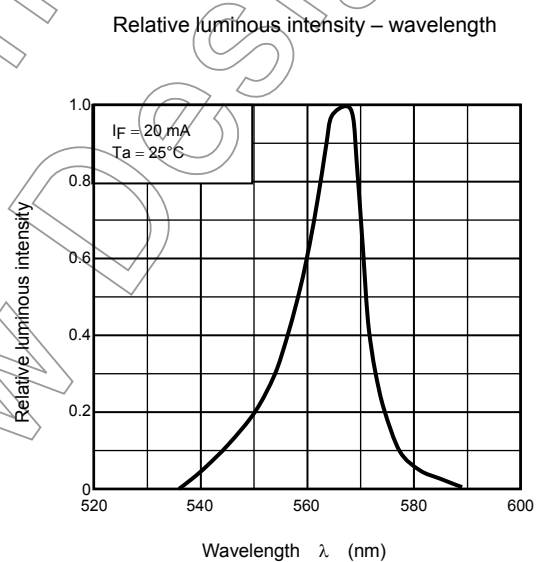
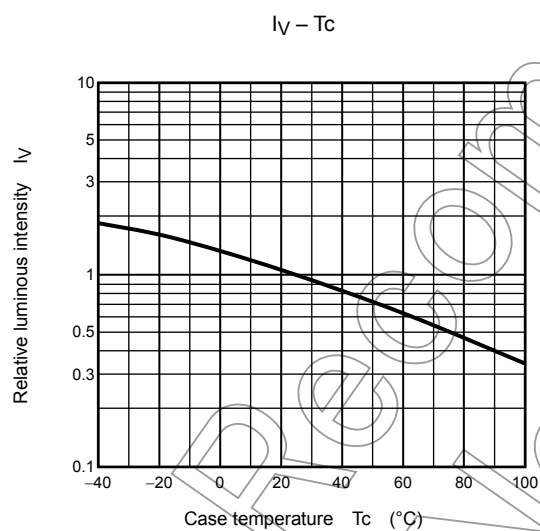
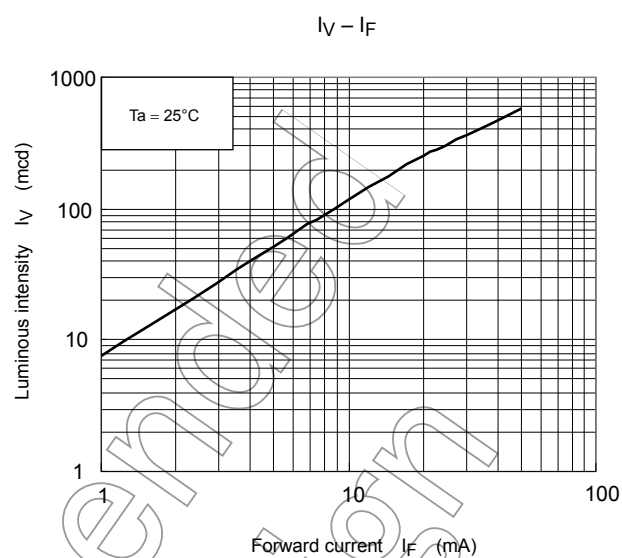
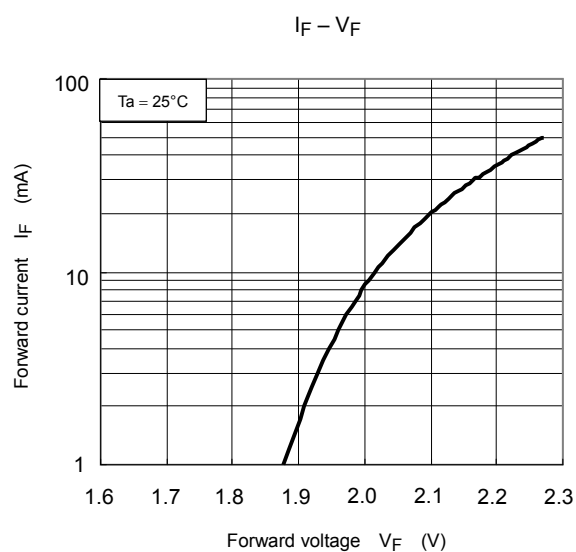
TLYH1050



TLGH1050



TLFGH1050



Packaging

These LED devices are packed in an aluminum envelope with silica gel and a moisture indicator to prevent moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

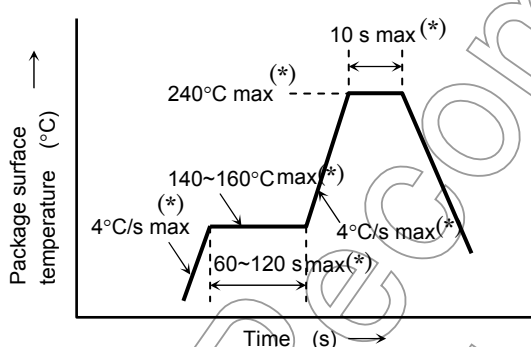
1. This moisture-proof bag may be stored unopened for up to 12 months under the following conditions.
Temperature: 5°C~30°C
Humidity: 90% (max)
2. After the moisture-proof bag has been opened, the devices should be assembled within 72 hours in an environment of 5°C to 30°C/70% RH or below.
3. If, upon opening, the moisture indicator card shows humidity of 30% or above (when the indication color changes to pink) or the expiration date has passed, the devices should be baked while packed in the tape reel. After baking, use the baked devices within 72 hours, but perform baking only once.
Baking conditions: 60 ±5°C, for 12 to 24 hours.
Expiration date: 12 months from the sealing date, which is imprinted on the same side as this label.
4. Repeated baking may cause the peeling strength of the tape to change, leading to trouble in mounting. Also, be sure to prevent damage to the device from static electricity during the baking process.
5. Any breakage in the laminate packing material will cause the hermeticity of the product to deteriorate. Do not toss or drop the packed devices.

Mounting Method

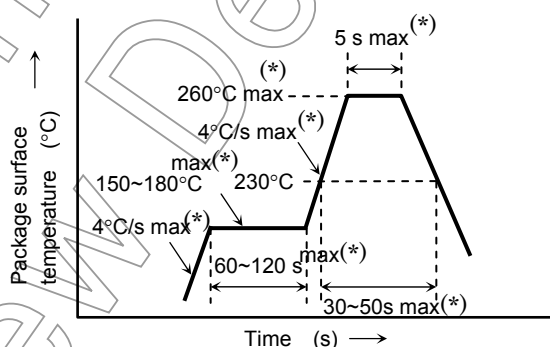
Soldering

- Reflow soldering (example)

Temperature profile for Pb soldering (example)

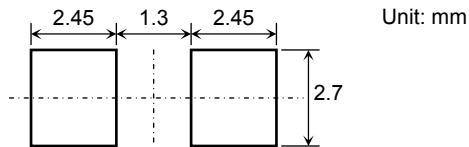


Temperature profile for Pb-free soldering (example)



- The product is evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)max values) as a evaluation. Please perform reflow soldering under the above conditions.
- Perform the first reflow soldering in accordance with the above temperature profile and within 72 hours of opening the package.
- Second time reflow
In case of second reflow soldering should be performed within 72 hours of the first reflow under the above conditions.
Storage conditions before the second reflow soldering: 5~30°C, 70% RH max
- Do not perform flow soldering and soldering dip.
- Make any necessary soldering corrections manually.
(only once at each soldering point)
Soldering iron: Less than 25 W
Temperature : Less than 350°C or less
Time : within 3 s (Up to once per place)

Recommended soldering pattern



Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents. Our dipping tests (carried out under the recommended conditions) confirm that these solvents have no effect on semiconductor devices. In selecting the cleaning solvent you will actually use, be sure to take into account the cleaning conditions and usage conditions.

Cleaning Solvent

ASAHI CLEAN AK-225AES
KAO CLEAN THROUGH 750H
PINE ALPHA ST-100S

Manufacturer

ASAHI GLASS
KAO
ARAKAWA CHEMICAL

Precautions When Mounting

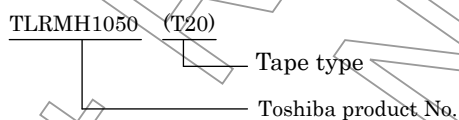
Do not apply force to plastic parts of the LED under high-temperature conditions. The LED plastic is easily scratched. Avoid friction between plastic parts and hard objects or materials. When installing the PCB in a product, ensure that the device does not come into contact with other components. This product doesn't apply mounting that solder flow. Please mount on recommended reflow solder mounting condition.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (This method, however, does not apply to products whose electrical characteristics differ from standard Toshiba specifications.)

- (1) Tape Type: T20 (8-mm pitch)
- (2) Example



2. Handling precautions

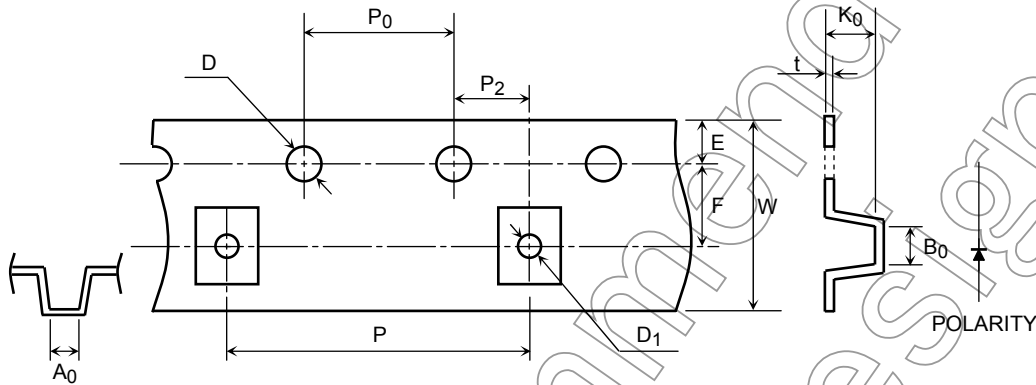
Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

- (a) In process, taping materials may sustain an electrostatic charge, use an ionizer to neutralize the ions.
- (b) For transport and temporary storage of devices, use containers(boxes, jigs, and bags) that are made of anti-static materials or of materials that dissipate electrostatic electricity.

3. Tape dimensions

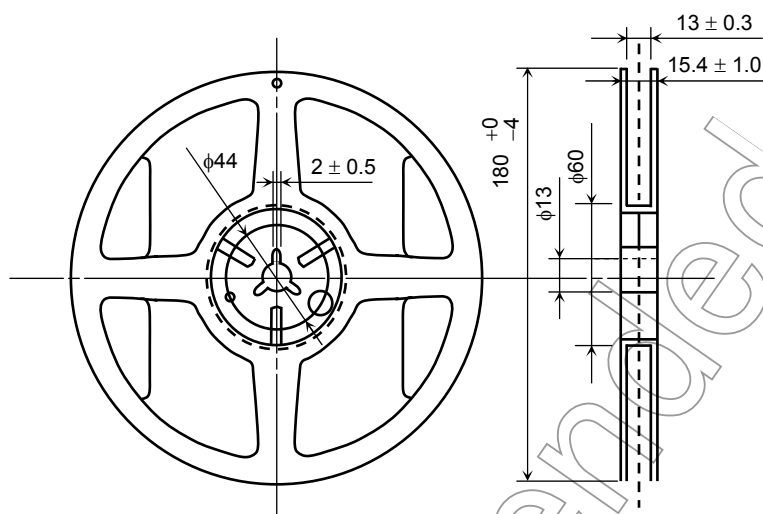
(Unit: mm)

Symbol	Dimension	Tolerance	Symbol	Dimension	Tolerance
D	1.5	+0.1/-0	P ₂	2.0	±0.05
E	1.75	±0.1	W	12.0	±0.2
P ₀	4.0	±0.1	P	8.0	±0.1
t	0.4	±0.05	A ₀	5.5	±0.1
F	5.5	±0.05	B ₀	5.5	±0.1
D ₁	1.6	±0.1	K ₀	4.4	±0.1

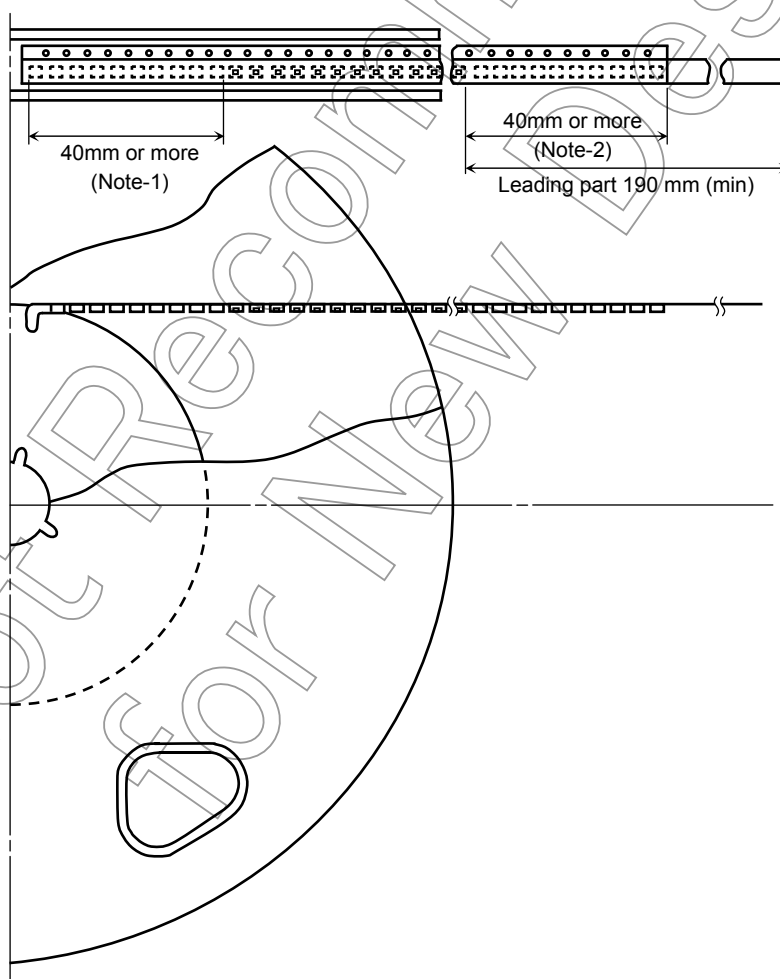


4. Reel dimensions

Unit: mm



5. Leader and trailer section of tape



Note-1 : Empty trailer section
Note-2 : Empty leader section

6. Packing form

(1) Packing quantity

Reel	400 pcs
Carton	2,000 pcs

(2) Packing form: Each reel is sealed in an aluminum pack with silica gel.

7. Label format

(1) Example : TLRMH1050(T20)

P/N:



TYPE	TLRMH1050		
ADDC	(T20)	Q'TY	400 pcs

Lot Number Key code for TSB 32C 400
(RANK SYMBOL)

Use under 5-30degC/70%RH within 168h

[[G]]/RoHS COMPATIBLE
Y380xxxxxxxxxxxxxxxxx

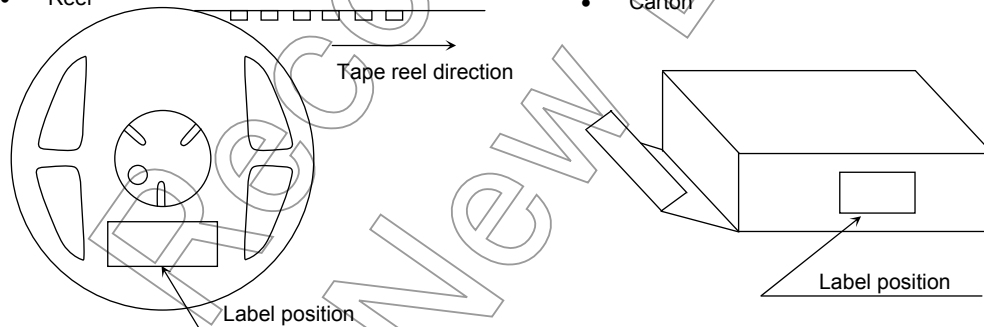
SEALING
DIFFUSED IN *****
ASSEMBLED IN *****

(2) Label location

• Reel

• Carton



- The aluminum package in which the reel is supplied also has a copy of the label attached to the center of one side.

*The Lot Number includes the following information.

Example: 270 7 B 3 B → "Packaged February 22, 2007"

a b c d e

a: Domestic ID

b: Last digit of the year (CE): "0" (Y2000), "1" (Y2001), "2" (Y2002) ~ "9" (Y2009)

Repeated for each decade

c: Month: "A" (Jan), "B" (Feb), "C" (Mar) ~ "L" (Dec)

d: Decade of the month: "1" (First), "2" (Middle), "3" (Last)

e: Day in d above: "A" (1st), "B" (2nd), "C" (3rd) ~ "J" (9th), "K" (10th)

"L" denotes the 31st of the month

"I" is not used to denote a day in this date system

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